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Texas Instruments 78ST233VC

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Datasheet of 78ST233VC - REGULATOR 3.3V 2A 3PSIP VRT

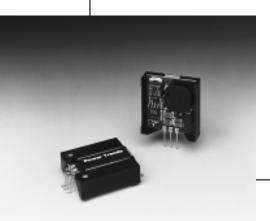
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78ST200

**2 AMP POSITIVE STEP-DOWN INTEGRATED SWITCHING REGULATOR** 

Revised 6/30/98

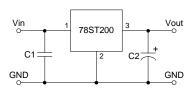


- High Efficiency > 82%
- Wide Input Range
- Self-Contained Inductor
- Short-Circuit Protection
- Over-Temperature Protection
- Fast Transient Response

The 78ST200 is a series of wide input voltage, 3 terminal Integrated Switching Regulators (ISRs). Employing a ceramic substrate, these ISRs have a maximum output current of 2A. The output voltage is laser trimmed for high accuracy.

The 78ST200 series regulators have internal short-circuit and overtemperature protection and may be used in a wide variety of applications.

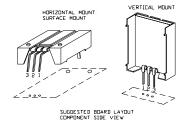
## **Standard Application**



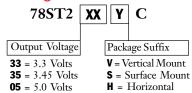
C1 = Optional 1µF ceramic C2 = Required 100µF electrolytic

### **Pin-Out Information**

Pin No.	Function
1	$V_{in}$
2	GND
3	$V_{out}$



**Ordering Information** 



Mount

(For dimensions and PC board layout see Package Style 500.)

#### **Specifications**

Characteristics			78ST20				
(T <sub>a</sub> = 25°C unless noted)	Symbols	Conditions	Min	Тур	Max	Units	
Output Current	$I_{o}$	Over V <sub>in</sub> range	0.1*	_	2.0	A	
Input Voltage Range	$V_{in}$	$I_o = 0.1 \text{ to } 3.0\text{A}$ $V_o < 3.5\text{V}$ $V_o = 5.0\text{V}$	7 8	_	15 20	V V	
Output Voltage Tolerance	$\Delta { m V}_{ m o}$	Over $V_{in}$ range, $I_o = 2.0A$ $T_a = 0$ °C to +60°C	_	±1.0	±2.0	%Vo	
Line Regulation	Regline	Over V <sub>in</sub> range	_	±0.4	±0.8	$%V_{o}$	
Load Regulation	Regload	$0.1 \le I_o \le 2.0A$	_	±0.2	±0.4	$%V_{o}$	
Ripple/Noise	$V_n$	$V_{in} = V_{in} \min$ , $I_o = 2.0A$	_	1	_	%Vo	
Transient Response (with 100µF output cap)	t <sub>tr</sub>	50% load change Vo over/undershoot	_	100 5.0	_	μSec %V <sub>o</sub>	
Efficiency	η	$V_{in} = 9V$ , $I_o = 2.0A$ , $V_o = 5V$	_	82	_	%	
Switching Frequency	$f_{0}$	Over V <sub>in</sub> and I <sub>o</sub> ranges	0.95	1.0	1.05	MHz	
Absolute Maximum Operating Temperature Range	$T_a$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			°C		
Recommended Operating Temperature Range	$T_a$		-40	_	+85**	°C	
Thermal Resistance	$\theta_{\mathrm{ja}}$	Free Air Convection, (40-60LFM)	_	38	_	°C/W	
Storage Temperature	$T_s$	_	-40		+125	°C	
Mechanical Shock	_	Per Mil-STD-883D, Method 2002.3	_	500		Gʻs	
Mechanical Vibration	_	Per Mil-STD-883D, Method 2007.2, 20-2000 Hz, soldered in a PC board	_	5	_	G's	
Weight	_	_	_	7	_	Gram	

 $<sup>^{\</sup>star}$   $\,$  ISR will operate down to no load with reduced specifications.

Note: The 78ST200 Series requires a 100µF electrolytic or tantalum output capacitor for proper operation in all applications.

<sup>\*\*</sup> See Thermal Derating chart.

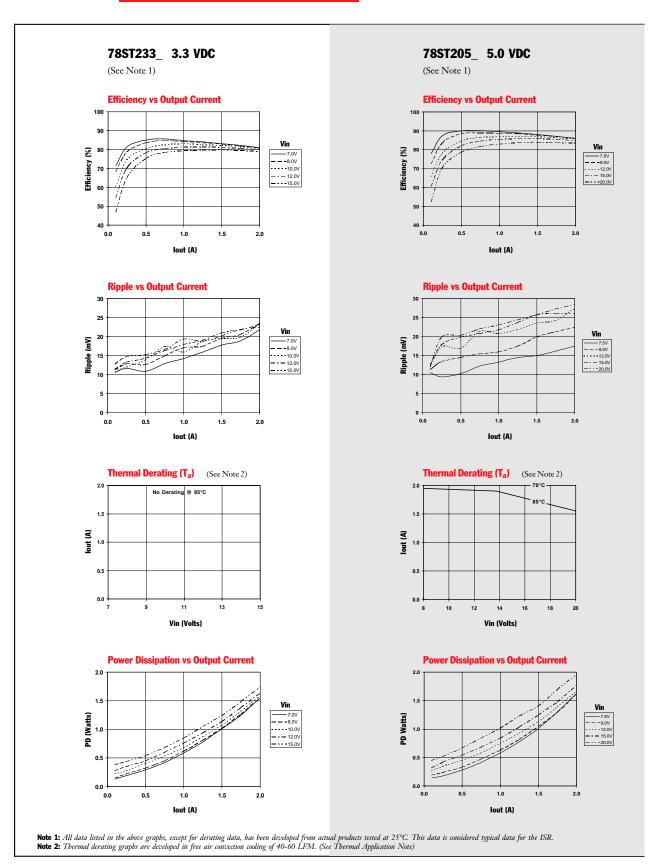
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#### CHARACTERISTIC DATA





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PACKAGE OPTION ADDENDUM

2-Feb-2014

## PACKAGING INFORMATION

Orderable Device	Status	Package Type		Pins		Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
78ST205SCT	OBSOLETE	SIP MODULE	EFC	3		TBD	Call TI	Call TI	-40 to 85		
78ST235HC	NRND	SIP MODULE	EFA	3		TBD	Call TI	Call TI	-40 to 85		
78ST235SC	OBSOLETE	SIP MODULE	EFC	3		TBD	Call TI	Call TI	-40 to 85		
78ST235VC	OBSOLETE	SIP MODULE	EFD	3		TBD	Call TI	Call TI	-40 to 85		

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above

Green (RoHS & no Sb/Br): Til defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish

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Addendum-Page 1



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PACKAGE OPTION ADDENDUM

IEXAS INSTRUMENTS
2-Feb-2014

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